

60V Dual N-Channel Enhancement Mode MOSFET

Description

The PECN4828 uses advanced trench technology to provide excellent $R_{DS(ON)}$ with low gate charge.

This device is suitable for high side switch in SMPS and general purpose applications.

General Features

- ◆ $V_{DS} = 60V, I_D = 7.5A$
 $R_{DS(ON)} = 31.5m\Omega$ (typical) @ $V_{GS} = 10V$
 $R_{DS(ON)} = 35m\Omega$ (typical) @ $V_{GS} = 4.5V$
- ◆ Excellent gate charge x $R_{DS(ON)}$ product(FOM)
- ◆ Very low on-resistance $R_{DS(ON)}$
- ◆ 150 °C operating temperature
- ◆ Pb-free lead plating
- ◆ 100% UIS tested

Application

- ◆ DC/DC Converter
- ◆ Ideal for high-frequency switching and synchronous rectification

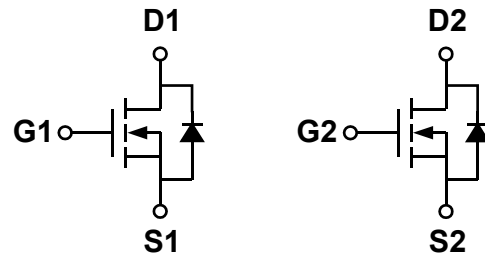
Package

- ◆ SOP-8

100% UIS TESTED!

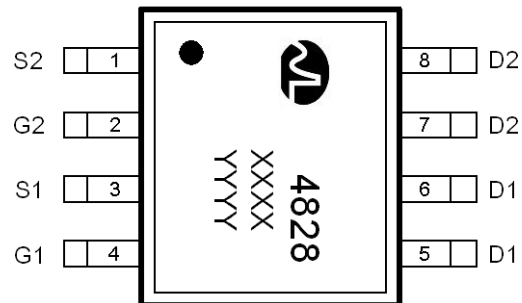
100% ΔV_{ds} TESTED!

Schematic diagram



Marking and pin assignment

SOP-8
(TOP VIEW)



Note: XXXX is the date code ,
YYYY is Quality code.

Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
PECN4828SR-G	-55°C to +150°C	SOP-8	4000

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter	symbol	limit	unit
Drain-source voltage	V_{DS}	60	V
Gate-source voltage	V_{GS}	± 20	V
Drain Current-Continuous (Silicon Limited)	I_D	$T_C = 25^\circ C$	7.5
		$T_C = 70^\circ C$	5.7
		$T_A = 25^\circ C$	5.4 ^{A,B}
		$T_A = 70^\circ C$	4.5 ^{A,B}
Pulsed Drain Current (Package Limited)	I_{DM}	30	A
Single pulse avalanche energy (L=0.1mH)	E_{AS}	30	mJ
Maximum power dissipation	P_D	3.7	W

	$T_C=70^{\circ}\text{C}$		2.6	
	$T_A=25^{\circ}\text{C}$		2.4 ^{A,B}	
	$T_A=70^{\circ}\text{C}$		1.7 ^{A,B}	
Operating junction Temperature range		T_j	-55—150	$^{\circ}\text{C}$

Thermal Characteristics

Parameter		Symbol	Typ	Max	Unit
Maximum Junction-to-Ambient ^A	$\leq 10\text{s}$	$R_{\theta JA}$	33	40	$^{\circ}\text{C}/\text{W}$
Maximum Junction-to-Ambient ^A	Steady-State		59	75	
Maximum Junction-to-Lead ^D	Steady-State	$R_{\theta JC}$	16	24	

A: The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}\text{C}$. The value in any given application depends on the user's specific board design. The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.

B: $t=10\text{s}$

C: Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

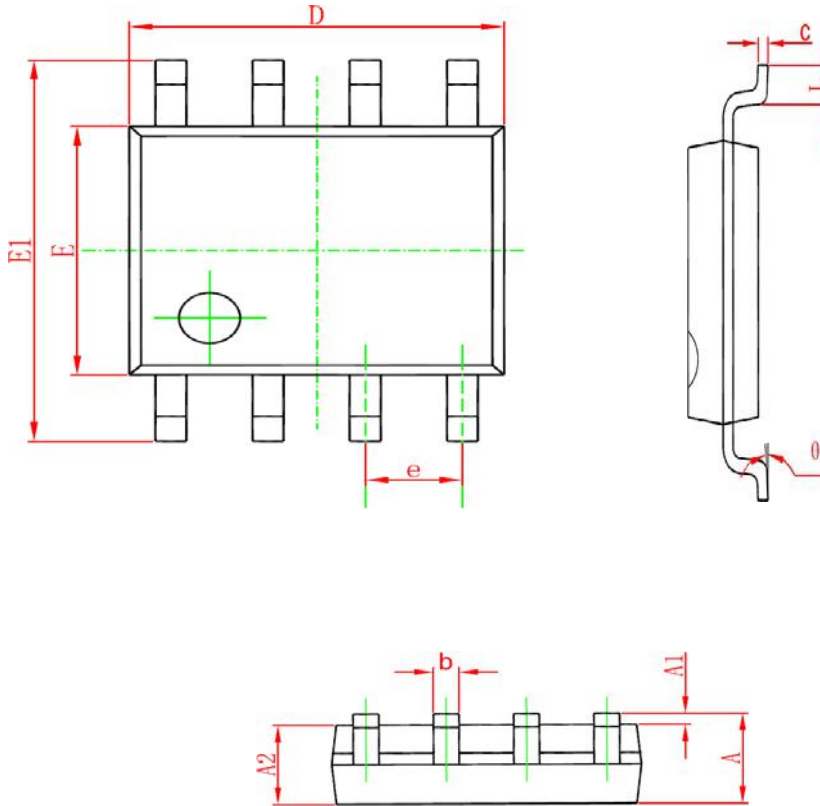
D: The $R_{\theta JA}$ is the sum of the thermal impedance from junction to lead $R_{\theta JC}$ and lead to ambient.

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF Characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	60	-	-	V
Zero gate voltage drain current	I_{DSS}	$V_{DS}=60V, V_{GS}=0V$	-	-	1	μA
Gate-body leakage	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$	-	-	± 100	nA
ON Characteristics						
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.2	1.9	2.	V
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=4A$	-	31.5	35	m Ω
		$V_{GS}=4.5V, I_D=3A$	-	35	40	
Forward transconductance	g_{fs}	$V_{DS}=5V, I_D=4A$	-	28	-	S
Dynamic Characteristics						
IPECNut capacitance	C_{ISS}	$V_{DS}=30V, V_{GS}=0V$ $f=1.0MHz$	-	450	-	pF
Output capacitance	C_{OSS}		-	60	-	
Reverse transfer capacitance	C_{RSS}		-	25	-	
Gate resistance	R_g	$V_{GS}=0V, V_{DS}=0V,$ $f=1.0MHz$	-	0.68	0.8	Ω
Switching Characteristics						
Turn-on delay time	$t_{D(ON)}$	$V_{DS}=30V$ $V_{GS}=10V$ $R_L=1.5\Omega$ $R_{GEN}=3\Omega$	-	4.7	-	ns
Rise time	t_r		-	2.3	-	
Turn-off delay time	$t_{D(OFF)}$		-	15.7	-	
Fall time	t_f		-	1.9	-	
Total gate charge	Q_g	$V_{DS}=30V, I_D=4A$ $V_{GS}=10V$	-	8.8	-	nC
Gate-source charge	Q_{gs}		-	1.6	-	
Gate-drain charge	Q_{gd}		-	2.2	-	

Package Information

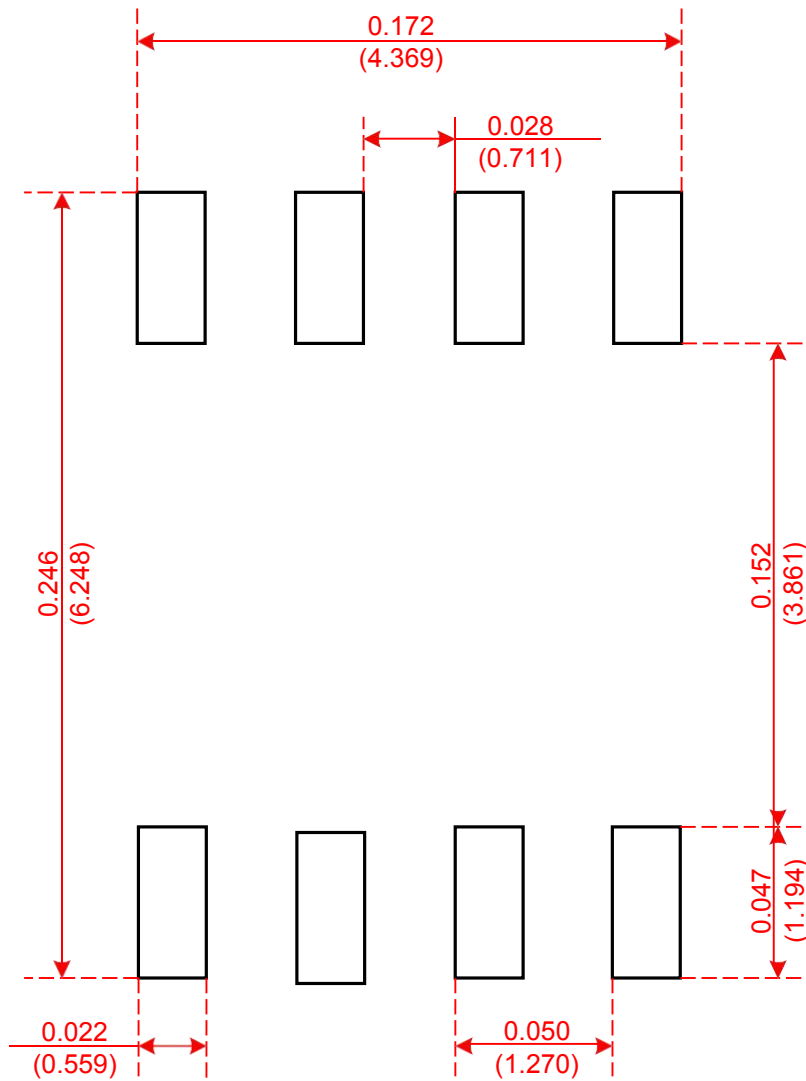
- SOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

Recommended Minimum Pads

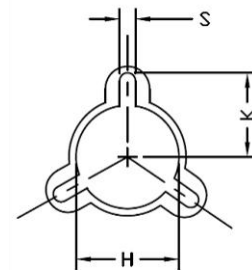
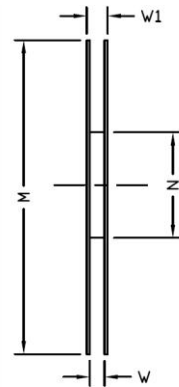
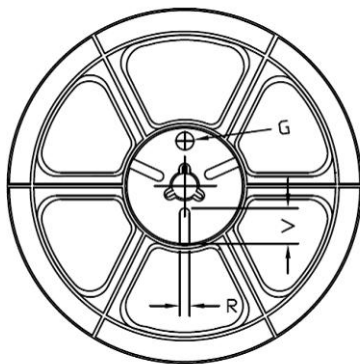
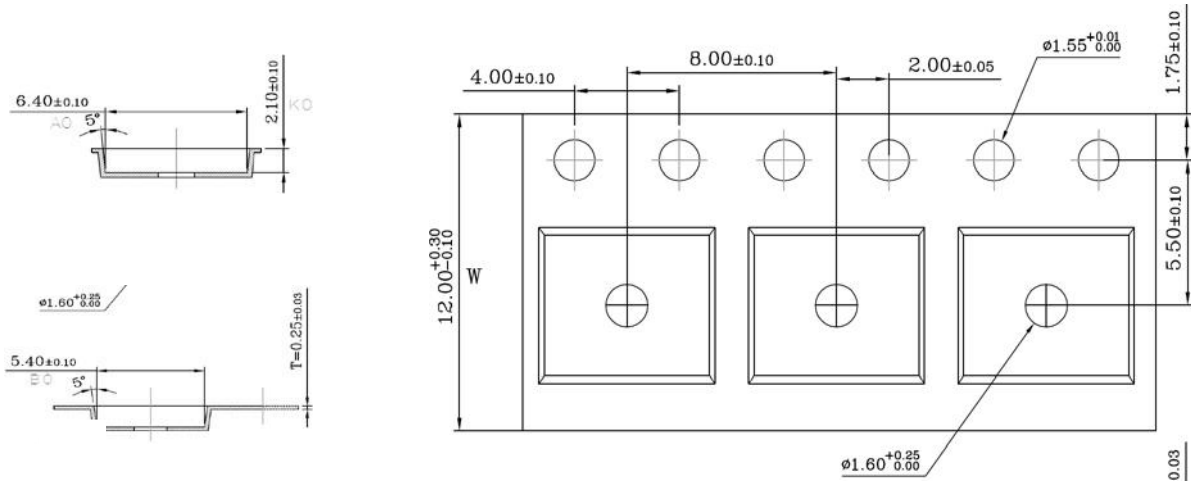
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**Recommended Minimum Pads
Dimensions in Inches/(mm)**

Tape and Reel

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Tape Size	Reel Size	M	N	W	W1	H	K	S	G	R	V
12mm	Φ330	Φ330.00 ±0.50	Φ97.00 ±0.30	13.00 ±0.30	17.40 ±1.00	Φ13.00 ±0.5	10.6	2.00 ±0.50	—	—	—

Unit Per Reel:
4000pcs

